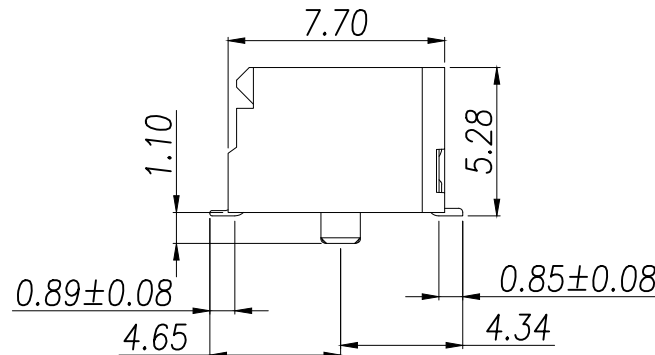
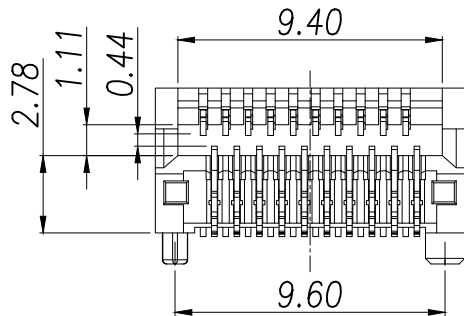
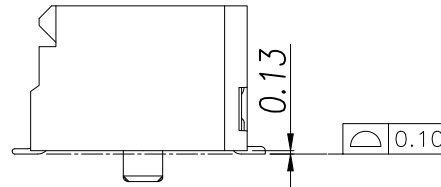
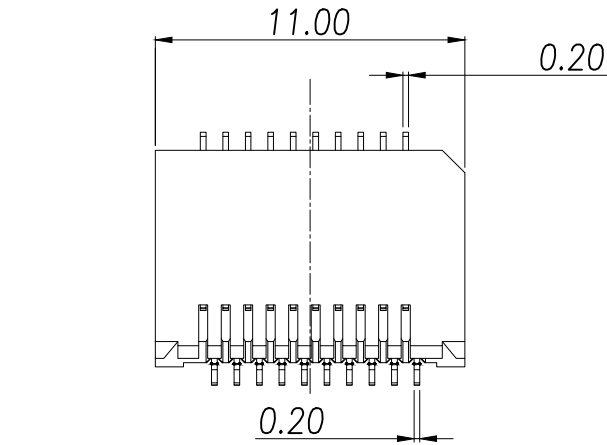




NOTES:

1.MATERIAL

HOUSING:HIGH TEMPERATURE LCP, Black,UL94 V-0

2.CONTACTS:PHOSPHOR BRONZE

PLATING :15*GOLD ON MATING AREA,
GOLD FLASH PLATING ON
SOLDER TAILS.50*NICKEL
UNDERPLATING OVERALL.

3.MECHANICAL REQUIREMENT:

3.1 DURABILITY:100 CYCLES MIN.

3.2 INSERTION AND EXTRACTION FORCE:40N MAX.& 11.5N MAX

4.ENVIRONMENTAL:

4.1 CONTACT RESISTANCE:20 MILLIOHMS MAXINITIAL.

4.2 DIELECTRIC WITHSTANDING VOLTAGE: 300V AC/MIN

4.3 CURRENT RATING:0.5 Amps Max.

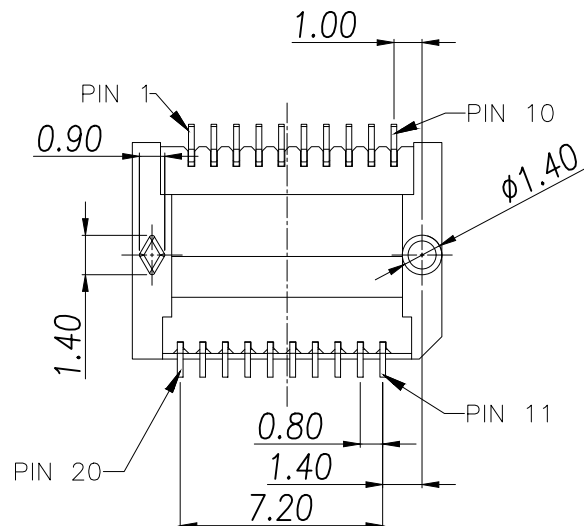
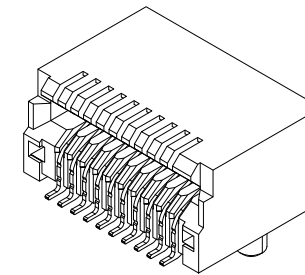
4.4 OPERATION:-40°C TO +95°C

4.5 STORAGE:-55°C TO +105°C

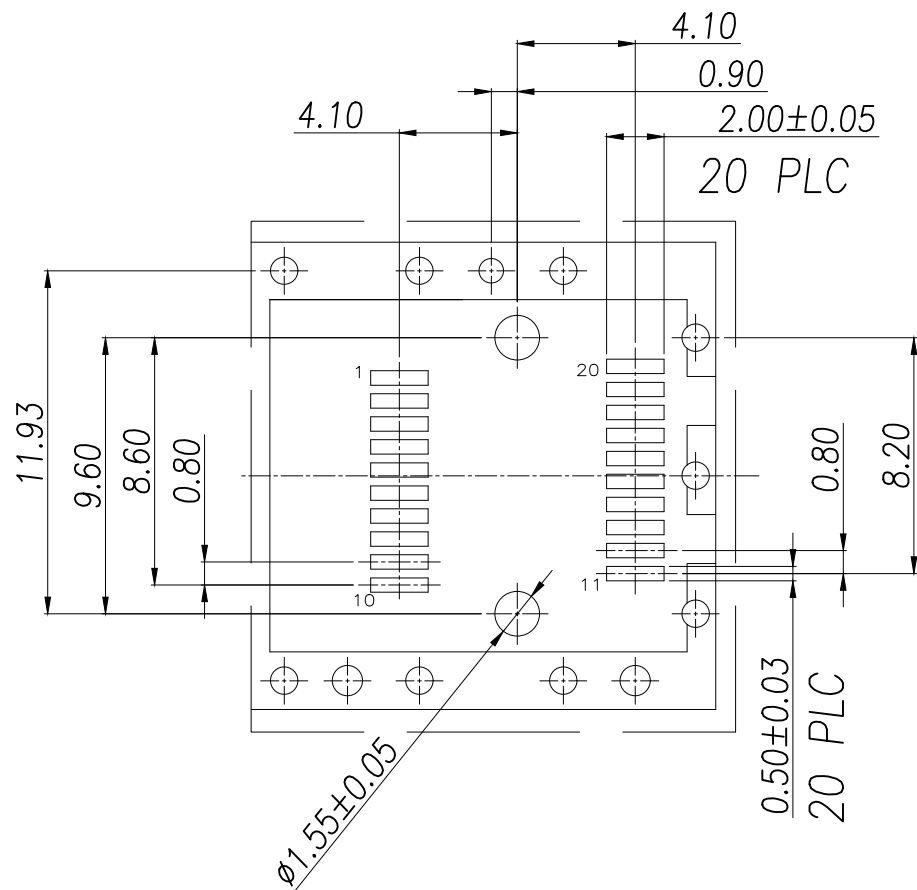
4.6 REFLOW SOLDERING TEMPERATURE:255~265*MAXIMUM FOR 5~10 SECONDS

4.9 ROHS COMPLIANT

5.PACKAGING:TAPE AND REEL

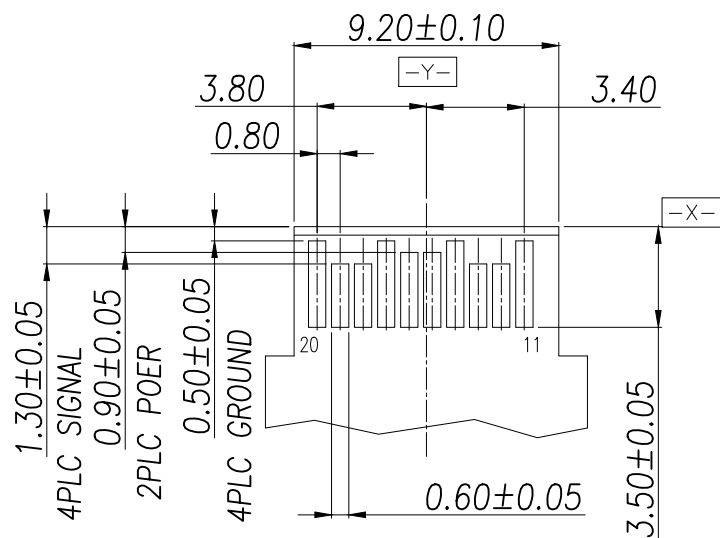


DIMENSION IN mm		厦门市辛译精密电子有限公司 Xiamen XinYi Xyconn Electronics Co.,Ltd			
TOLERANCE UNLESS OTHERWISE SPECIFIED		APR.	Alex	TITLE: SFP+ 1X1CONNECTOR	
.X±0.30	X.*± 5°	CHK.	Jack	DWG NO. XY-SFP-15U	
.XX±0.25	.X*± 1	PROJ.	Can	CUSTOMER DRAWING	
.XXX±0.15	.XX*±	SIZE	A4	SCALE	1:1
		SHEET	1/1	REV.	A



PCB.WELDING DRAWING (TOLERANCE:±0.05)

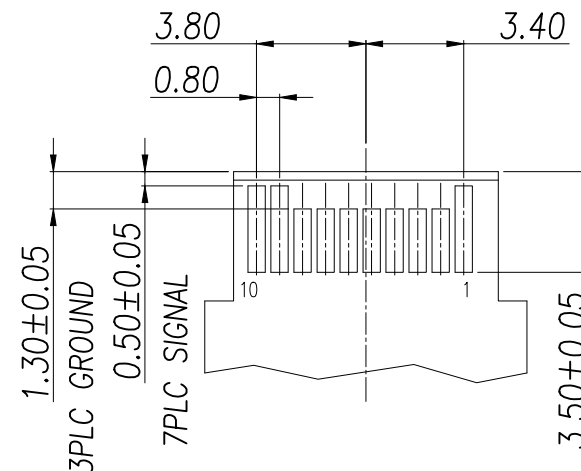
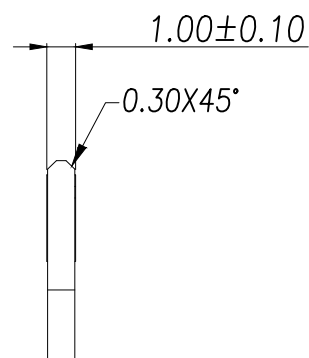
DIMENSION IN mm		厦门市辛译精密电子有限公司 Xiamen XinYi Xyeconn Electronics Co.,Ltd			
TOLERANCE UNLESS OTHERWISE SPECIFIED					
.X±0.30	.X°± 5°	APR. Alex	TITLE: SFP+ 1X1CONNECTOR		
.XX±0.25	.X°± 1	CHK. Jack	DWG NO. XY-SFP-15U		
.XXX±0.15	.XX°±	DRA. Can	PROJ. 	CUSTOMER DRAWING	
			SIZE A4	SCALE 1:1	SHEET 1 / 1



⌀0.10 X Y

20PLC

TOP VIEW OF BOARD



BOTTOM VIEW OF BOARD

RECOMMENDED LAYOUT DETAIL MATING TRANSCEIVER PCB

DIMENSION IN mm		厦门市辛译精密电子有限公司 Xiamen XinYi Xyeconn Electronics Co.,Ltd				
TOLERANCE UNLESS OTHERWISE SPECIFIED						
.X±0.30	X.*± 5°	APR. Alex	TITLE: SFP+ 1X1CONNECTOR			
.XX±0.25	.X*± 1	CHK. Jack	DWG NO. XY-SFP-15U			
.XXX±0.15	.XX*±	DRA. Can	PROJ. 		CUSTOMER DRAWING	
			SIZE A4	SCALE 1:1	SHEET 1/1	REV. A